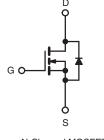
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY							
V _{DS} (V) at T _J max.	700						
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.145					
Q _g max. (nC)	122						
Q _{gs} (nC)	21						
Q _{gd} (nC)	37						
Configuration	Single						





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	D ² PAK (TO-263)				
	SiHB24N65E-GE3				
Lead (Pb)-free and Halogen-free	SiHB24N65ET1-GE3				
	SiHB24N65ET5-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)							
PARAMETER	SYMBOL	LIMIT	UNIT				
Drain-Source Voltage			V _{DS}	650	v		
Gate-Source Voltage			V _{GS}	V _{GS} ± 30			
Continuous Droin Current (T. 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	24			
Continuous Drain Current (T _J = 150 °C)	$V_{\rm GS}$ at 10 V	T _C = 100 °C		16	А		
Pulsed Drain Current ^a		I _{DM}	70				
Linear Derating Factor			2	W/°C			
Single Pulse Avalanche Energy ^b			E _{AS}	508	mJ		
Maximum Power Dissipation	PD	250	W				
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C				
Drain-Source Voltage Slope		37					
Reverse Diode dV/dt ^d	dV/dt	11	V/ns				
Soldering Recommendations (Peak Temperature) ^c		300	°C				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_a = 25 \Omega$, $I_{AS} = 6$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62		20.44		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	- 0.5				°C/W	
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					Į	I	l	Į
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I _D = 250 μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	 250 μA	2	-	4	V
	00(0)		$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 1	μA
			= 650 V, V ₀		-	-	1	μA
Zero Gate Voltage Drain Current	I _{DSS}			V, TJ = 125 °C	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		l _D = 12 A	-	0.120	0.145	Ω
Forward Transconductance	g fs	V _{DS} = 8 V, I _D = 5 A		-	7.1	-	S	
Dynamic					I		<u></u>	
Input Capacitance	C _{iss}		-	2740	-	pF		
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz			-		122	-
Reverse Transfer Capacitance	C _{rss}				-		4	-
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	93		-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$			-		352	-
Total Gate Charge	Qg				-	81	122	1
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 12 A, V _{DS} = 520 V		-	21	-	nC
Gate-Drain Charge	Q _{gd}				-	37	-	
Turn-On Delay Time	t _{d(on)}				-	24	48	ns
Rise Time	t _r	Voo =	= 520 V, I _D	= 12 A.	-	84	126	
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _g		-	70	105	
Fall Time	t _f					69	104	
Gate Input Resistance	R _g	f = 1	MHz, ope	n drain	-	0.68	-	Ω
Drain-Source Body Diode Characteristic	s	-			l	T		-
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	24	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode			-	-	70	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V			-	-	1.2	V
Reverse Recovery Time	t _{rr}	0			-	433	-	ns
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 12 A, dI/dt = 100 A/µs, V _R = 25 V			-	7.3	-	μC
Reverse Recovery Current	I _{RRM}				-	28		A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

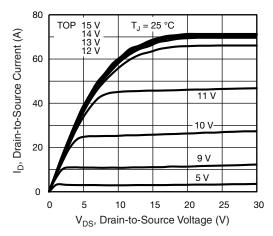


Fig. 1 - Typical Output Characteristics

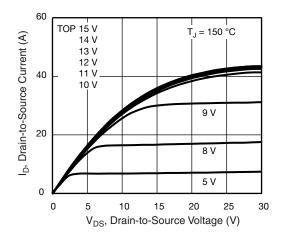


Fig. 1 - Typical Output Characteristics

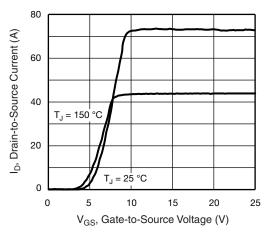


Fig. 2 - Typical Transfer Characteristics

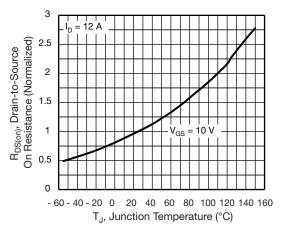


Fig. 3 - Normalized On-Resistance vs. Temperature

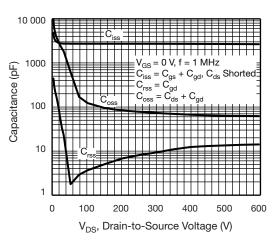
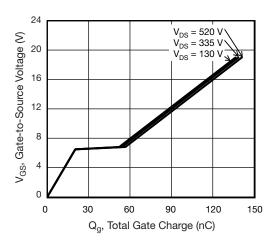


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage





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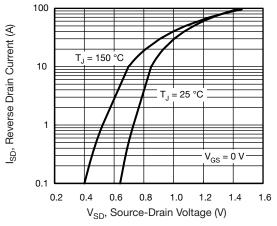


Fig. 6 - Typical Source-Drain Diode Forward Voltage

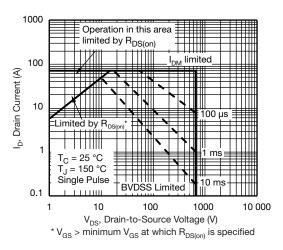


Fig. 7 - Maximum Safe Operating Area

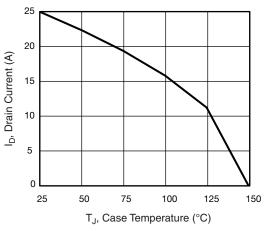


Fig. 8 - Maximum Drain Current vs. Case Temperature

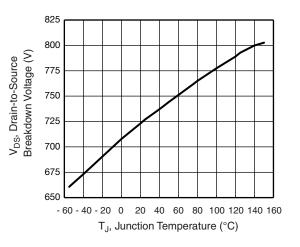
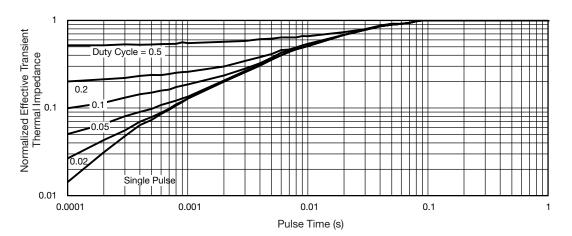


Fig. 9 - Temperature vs. Drain-to-Source Voltage





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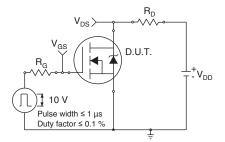


Fig. 11 - Switching Time Test Circuit

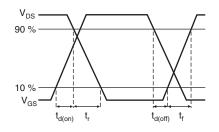


Fig. 12 - Switching Time Waveforms

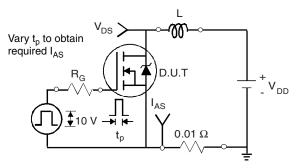


Fig. 13 - Unclamped Inductive Test Circuit

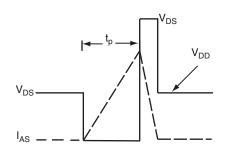
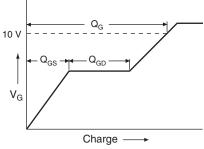


Fig. 14 - Unclamped Inductive Waveforms



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Fig. 15 - Basic Gate Charge Waveform

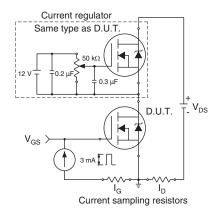
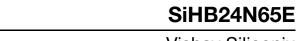


Fig. 16 - Gate Charge Test Circuit

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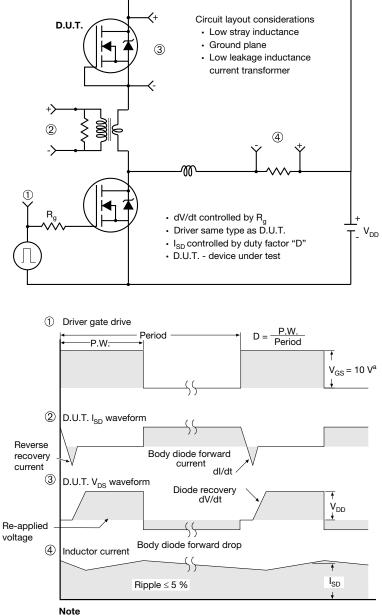
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 17 - For N-Channel

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Package Information

H

B

A1

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° tọ 8°

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Seating plane

TO-263AB (HIGH VOLTAGE)

3 /4

A

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Detail A

(Datum A)

D

<u>4</u> Lī

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	MILLIMETERS INCHES				MILLIMETERS		INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035		е	2.54 BSC 0.10		0.100) BSC
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010) BSC
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208
ECN: S-82 DWG: 597	110-Rev. A, 1)	15-Sep-08								

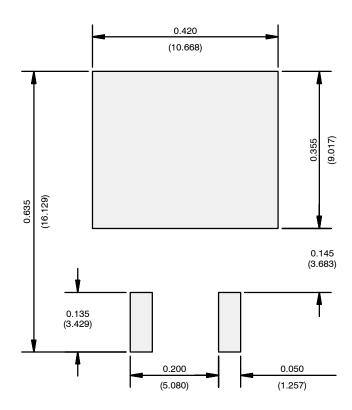
А

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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